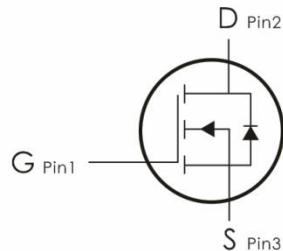
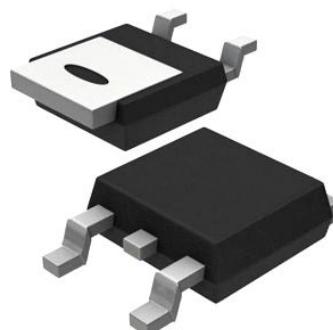


## Description:

This N-Channel MOSFET uses advanced trench technology and design to provide excellent  $R_{DS(on)}$  with low gate charge. It can be used in a wide variety of applications.



## Features:

- 1)  $V_{DS}=100V, I_D=15A, R_{DS(on)}<100m\Omega @V_{GS}=10V$
- 2) Low gate charge.
- 3) Green device available.
- 4) Advanced high cell density trench technology for ultra low  $R_{DS(on)}$ .
- 5) Excellent package for good heat dissipation.

## Package Marking and Ordering Information:

Part NO.	Marking	Package	Packing
DH090NG-S	H090N-S	TO- 252	2500 pcs/Reel

## Absolute Maximum Ratings: ( $T_C=25^\circ C$ unless otherwise noted)

Symbol	Parameter	Ratings	Units
$V_{DS}$	Drain-Source Voltage	100	V
$V_{GS}$	Gate-Source Voltage	$\pm 20$	V
$I_D$	Continuous Drain Current	15	A
	Continuous Drain Current- $T_C=100^\circ C$	9	
$I_{DM}$	Pulsed Drain Current <sup>1</sup>	60	
$P_D$	Power Dissipation	46	W
$E_{AS}$	Single pulse avalanche energy <sup>2</sup>	20	mJ
$T_J, T_{STG}$	Operating and Storage Junction Temperature Range	-55-+150	°C

## Thermal Characteristics:

Symbol	Parameter	Max	Units
$R_{eJC}$	Thermal Resistance,Junction to Case	2.7	°C/W

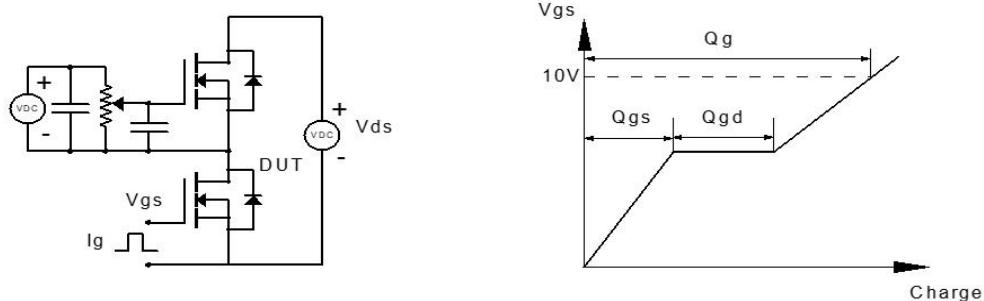
**Electrical Characteristics:** ( $T_C=25^\circ\text{C}$  unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
<b>Off Characteristics</b>						
<b><math>\text{BV}_{\text{DSS}}</math></b>	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250 \mu\text{A}$	100	---	---	V
<b><math>I_{\text{DSS}}</math></b>	Zero Gate Voltage Drain Current	$V_{\text{GS}}=0\text{V}, V_{\text{DS}}=100\text{V}$	---	---	1	$\mu\text{A}$
<b><math>I_{\text{GSS}}</math></b>	Gate-Source Leakage Current	$V_{\text{GS}}=\pm 20\text{V}, V_{\text{DS}}=0\text{A}$	---	---	$\pm 100$	nA
<b>On Characteristics</b>						
<b><math>V_{\text{GS}(\text{th})}</math></b>	GATE-Source Threshold Voltage	$V_{\text{GS}}=V_{\text{DS}}, I_{\text{D}}=250 \mu\text{A}$	1.2	1.8	2.4	V
<b><math>R_{\text{DS}(\text{ON})}</math></b>	Drain-Source On Resistance <sup>3</sup>	$V_{\text{GS}}=10\text{V}, I_{\text{D}}=10\text{A}$	---	75	100	$\text{m}\Omega$
		$V_{\text{GS}}=4.5\text{V}, I_{\text{D}}=8\text{A}$	---	85	110	$\text{m}\Omega$
<b>Dynamic Characteristics</b>						
<b><math>C_{\text{iss}}</math></b>	Input Capacitance	$V_{\text{DS}}=25\text{V}, V_{\text{GS}}=0\text{V}, f=1\text{MHz}$	---	1083	---	pF
<b><math>C_{\text{oss}}</math></b>	Output Capacitance		---	51	--	
<b><math>C_{\text{rss}}</math></b>	Reverse Transfer Capacitance		---	40	---	
<b>Switching Characteristics</b>						
<b><math>t_{\text{d(on)}}</math></b>	Turn-On Delay Time	$V_{\text{DS}}=50\text{V}, I_{\text{D}}=10\text{A}, R_{\text{ENG}}=3 \Omega, V_{\text{GS}}=10\text{V}$	---	13	---	ns
<b><math>t_r</math></b>	Rise Time		---	5.4	---	ns
<b><math>t_{\text{d(off)}}</math></b>	Turn-Off Delay Time		---	27	---	ns
<b><math>t_f</math></b>	Fall Time		---	5.1	---	ns
<b><math>Q_{\text{gs}}</math></b>	Total Gate Charge	$V_{\text{GS}}=10\text{V}, V_{\text{DS}}=50\text{V}, I_{\text{D}}=10\text{A}$	---	21	---	nc
<b><math>Q_{\text{gd}}</math></b>	Gate-Source Charge		---	2	---	nc
<b><math>Q_g</math></b>	Gate-Drain "Miller" Charge		---	6	---	nc
<b>Drain-Source Diode Characteristics</b>						
<b><math>V_{\text{SD}}</math></b>	Diode Forward Voltage	$V_{\text{GS}}=0\text{V}, I_{\text{SD}}=15\text{A}$	---	---	1.2	V
<b><math>I_s</math></b>	Continuous Drain Current	$V_D=V_G=0\text{V}$	---	---	15	A
<b><math>I_{\text{SM}}</math></b>	Pulsed Drain Current		---	---	60	A
<b><math>\text{Tr}_r</math></b>	Reverse Recovery Time	$I_F=10\text{A}, T_J=25^\circ\text{C}$	---	30	---	ns
<b><math>Q_{\text{rr}}</math></b>	Reverse Recovery Charge		---	42	---	nc

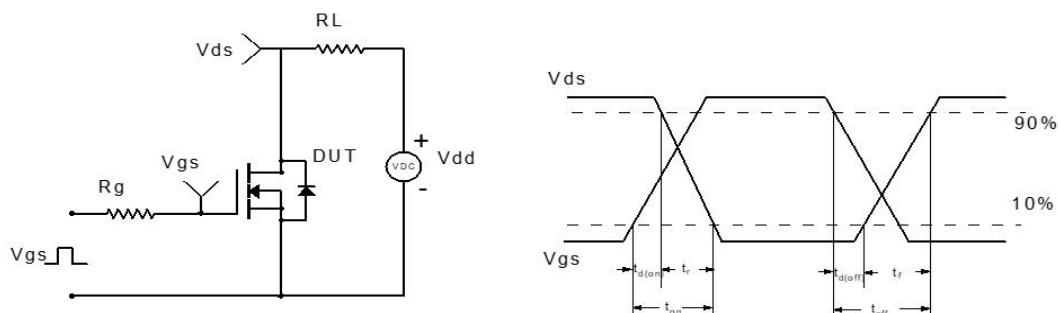
**Notes:**

1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.
2. EAS condition: Starting  $T_J=25C$ ,  $V_{DD}=50V$ ,  $V_G=10V$ ,  $R_G=25\Omega$ ,  $L=0.5mH$ ,  $I_{AS}=9A$
3. Pulse Test: Pulse Width  $\leq 300\mu s$ , Duty Cycle  $\leq 0.5\%$ .

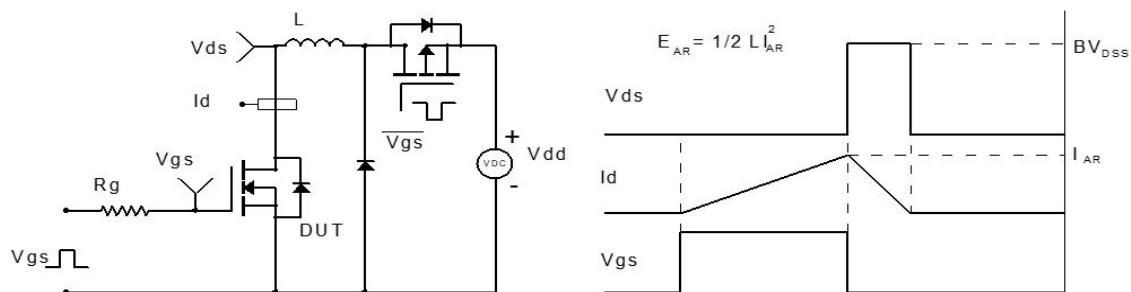
**Typical Characteristics:** ( $T_C=25^{\circ}C$  unless otherwise noted)



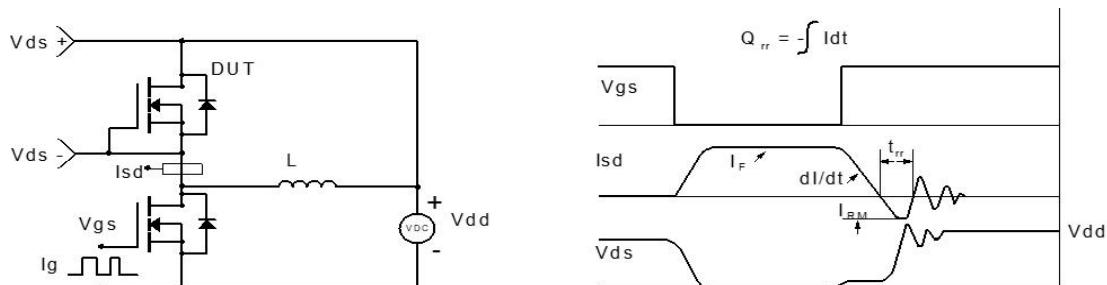
**Figure 1: Gate Charge Test Circuit & Waveform**



**Figure 2: Resistive Switching Test Circuit & Waveform**



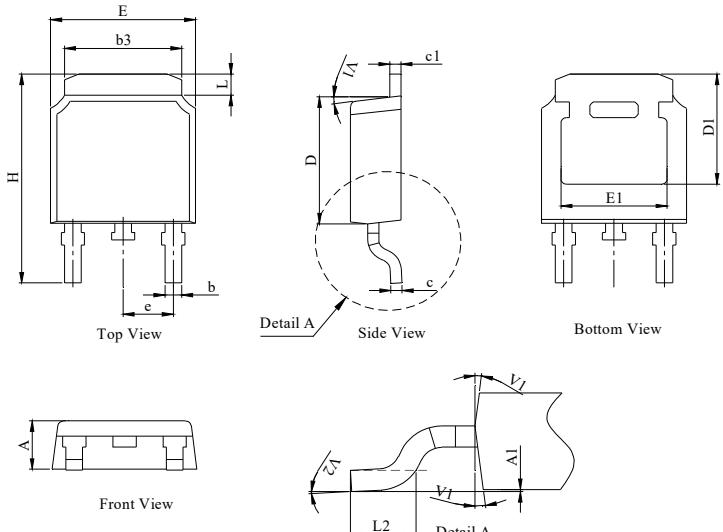
**Figure 3: Unclamped Inductive Switching Test Circuit & Waveform**



**Figure 4: Diode Recovery Test Circuit & Waveform**

## TO-252 Package Information

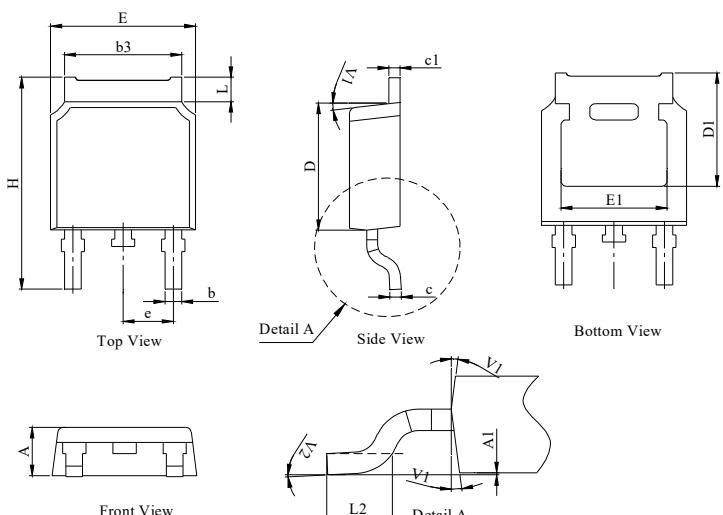
**Package Outline Type-A**



**UNIT: mm**

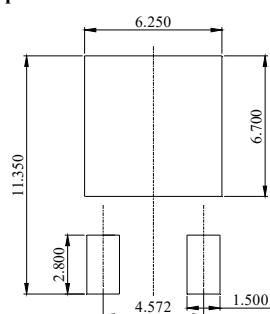
DIM.	MILLIMETER		
	MIN.	NOM.	MAX.
A	2.18	2.30	2.39
A1	0	--	0.13
b	0.64	0.76	0.89
c	0.40	0.50	0.61
c1	0.46	0.50	0.58
D	5.97	6.10	6.23
D1	5.05	--	--
E	6.35	6.60	6.73
E1	4.32	--	--
b3	5.21	5.38	5.55
e	2.29 BSC		
H	9.40	10.00	10.40
L	0.89	--	1.27
L2	1.40	--	1.78
V1	7° REF		
V2	0°	--	6°

**Package Outline Type-B**



DIM.	MILLIMETER		
	MIN.	NOM.	MAX.
A	2.10	2.30	2.40
A1	0	--	0.13
b	0.66	0.76	0.86
b3	5.21	5.38	5.55
c	0.40	0.50	0.60
c1	0.44	0.50	0.58
D	5.90	6.10	6.30
D1	5.30REF		
E	6.40	6.60	6.80
E1	4.63	-	-
e	2.29 BSC		
H	9.50	10.00	10.70
L	1.09	--	1.21
L2	1.35	--	1.65
V1	7° REF		
V2	0°	--	6°

**Recommended Soldering Footprint**



## Marking Information:

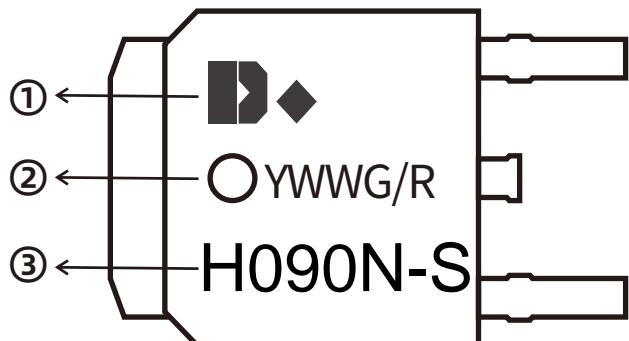
①. Doingter LOGO

②. Date Code(YWWG / R)

Y : Year Code , last digit of the year

WW : Week Code(01-53)

G/R : G(Green) /R(Lead Free)



③. Part NO.

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